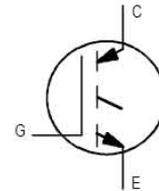


Features

- High short circuit rating optimized for motor control
- Low conduction losses
- High switching speed
- Tighter parameter distribution

$V_{CES}=1200\text{ V}$
 $V_{CE(on)\text{ typ. }}=3,1\text{ V}$
 @ $V_{GE}=15\text{ V}$, $I_C=45\text{ A}$



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Units	Max
Collector-to-Emitter Voltage	V_{CES}	V	1200
Continuous Collector Current	$I_C @ T_C=25^\circ\text{C}$	A	45
Continuous Collector Current	$I_C @ T_C=100^\circ\text{C}$		24
Pulsed Collector Current ¹	I_{CM}		90
Clamped Inductive Load Current ²	I_{LM}		90
Short Circuit Withstand Time	tsc	μS	10
Maximum Power Dissipation	$P_D @ T_C=25^\circ\text{C}$	W	200
Maximum Power Dissipation	$P_D @ T_C=100^\circ\text{C}$		78
Gate-to-Emitter Voltage	V_{GE}	V	± 20
Operating Junction and Storage temperature Range	T_J T_{STG}	$^\circ\text{C}$	-55 to +150
Soldering Temperature, for 10 seconds		$^\circ\text{C}$	300

THERMAL RESISTANCE

Parameter	Symbol	Units	Min	Typ.	Max
Junction-to-Case	$R_{\theta JC}$	$^\circ\text{C/W}$	-	-	0,64
Case-to-Sink, Flat, Greased Surface	$R_{\theta CS}$		-	0,24	-
Junction-to-Ambient, typical socket mount	$R_{\theta JA}$		-	-	40

ELECTRICAL CHARACTERISTICS (T_j =25 °C)

Parameter	Symbol	Units	Test Conditions	Min	Typ.	Max
Collector-to-Emitter Breakdown Voltage	V _{(BR)CES}	V	V _{GE} = 0V, I _C = 250μA	1200	-	-
Emitter-to-Collector Breakdown Voltage	V _{(BR)ECS}	V	V _{GE} = 0V, I _C = 1A	18	-	-
Breakdown Voltage Temp.Coefficient	ΔV _{(BR)CES} /ΔT _J	V/°C	V _{GE} = 0V, I _C = 2 mA	-	0,9	-
Collector-to-Emitter Saturation Voltage (see figure 2,5)	V _{CE(ON)}	V	V _{GE} = 15V, I _C = 24A	-	2,6	3,5
			V _{GE} = 15V, I _C = 45A	-	3,1	-
			V _{GE} = 15V, I _C = 24A T _J =150°C	-	2,6	-
Gate Threshold Voltage	V _{GE(th)}	V	V _{GE} =V _{CE} , I _C =250 μA	3,0	-	6,0
Threshold Voltage Temp.Coefficient	ΔV _{(GE)th} /ΔT _J	mV/°C	V _{GE} =V _{CE} , I _C =2mA	-	-10	-
Forward Transconductance	g _(fe)	S	V _{CE} = 100V, I _C = 24 A	13	19	-
Zero Gate Voltage Collector Current	I _{CES}	μA	V _{CE} = 1200V, V _{GE} =0V	-	-	250
			V _{CE} = 10V, V _{GE} =0V	-	-	2,0
			V _{CE} = 1200V, V _{GE} =0V T _J =150°C	-	-	5000
Gate-to-Emitter Leakage Current	I _{GES}	nA	V _{GS} = ±20V			±100

SWITCHING CHARACTERISTICS (T_j =25 °C)

Parameter	Symbol	Units	Test Conditions	Min	Typ.	Max
Total Gate Charge (turn on)	Q _g	nC	V _{GE} = 15V, V _{CC} = 400V, I _C =40A See Figure 8	-	180	270
Gate-to-Emitter Charge (turn on)	Q _{ge}			-	25	38
Gate-to-Collector Charge (turn on)	Q _{gc}			-	70	110
Turn-On Delay Time	t _{d(on)}	ns	V _{CC} =960V, I _C =240A V _{GE} = 15V R _G =24 Ω	-	36	-
Rise Time	t _r			-	27	-
Turn-Off Delay Time	t _{d(off)}			-	200	300
Fall Time	t _f			-	130	190
Turn-On Switching Loss	E _{on}	mJ	Energy losses include «tail» See Figure 9,10,14	-	1,21	
Turn-Off Switching Loss	E _{off}			-	2,25	
Total Switching Loss	E _{TS}			-	3,46	4,1
Short Circuit Withstand Time	t _{SC}	μS	V _{CC} =720V, T _J =125°C V _{GE} =15V R _G =5,0Ω	10	-	-
Turn-On Delay Time	t _{d(on)}	ns	T _J =150°C V _{CC} =960V, I _C =24A V _{GE} = 15V R _G =24 Ω Energy losses include «tail» See Figure 10,11,14	-	35	-
Rise Time	t _r			-	29	-
Turn-Off Delay Time	t _{d(off)}			-	380	-
Fall Time	t _f			-	280	-
Total Switching Loss	E _{TS}	mJ		-	7,80	-
Input Capacitance	C _{ISS}	pF	V _{GE} = 0V, V _{CC} = 30V, f = 1.0MHz See Figure 7	-	2800	-
Output Capacitance	C _{OSS}			-	140	-
Reverse Transfer Capacitance	C _{RSS}			-	53	-

NOTES:

- ¹ Repetitive rating; V_{GE} =20V, pulse width limited by max junction temperature.(Fig.13b)
- ² V_{CC} =80%(V_{CES}), L = 10 μH, V_{GE} = 15V, R_G =5,0 Ω,(Fig.13a)
- ³ Pulse width ≤80 μs, duty factor ≤0,1%.
- ⁴ Pulse width 5,0μs single short.